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__PATENT

Paper No.

File: Concir-2

11/Resp. 8/28/2 Surler

Date:____

August 7, 2002

D.C. 20231 on the date indicated below.

Peter K. Trzyna (Reg. No. 22,601)

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to the Commissioner of Patents and Trademarks, Washington,

rzyna (Reg. No. 82,601)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors

Brian J. McDermott, Jr., Daniel McGowan, Ralph

Leo Spotts, and Sid Tryzbiak

Serial No.

09/694,099

Filed

October 10, 2000

For

IMPROVED CIRCUIT BOARD OR OTHER MULTILAYER

ELECTRICAL DEVICE MADE BY FORMING TEETH TO

JOIN LAYERS

Group Art Unit

2827

Examiner

Dinh, Tuan T

Honorable Commissioner of Patents and Trademarks Washington, D.C. 20231

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT (37 C.F.R. 1.121)

SIR:

The amendment filed on July 1, 2002, was considered non-compliant beause a marked-up version of the replacement abstract was not filed.

In response to the Notice of Non-Complaint Amendment, enclosed is the Amended Version of the Abstract in the above-identified application.

The Commissioner is hereby authorized to charge any fees associated with the above-identified patent application or credit any overcharges to Deposit Account No. 50-0235.

Please direct all correspondence to the undersigned at the address given below.

Respectfully submitted,

Date: August 7, 2002

Peter K. Trzyna (Reg. No. 32,601)

P.O. Box 7131 Chicago, IL 60680-7131 (312) 240-0824



UNDER SECRETARY OF COMMERCE FOR INTELLECTUAL PROPERTY AND
DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, DC 20231
www.uspto.gov

COPY OF PAPERS ORIGINALLY FILED

Paper No.

Notice of Non-Compliant Amendment (37 CFR 1.121)

CFR the a	The amendment filed on 7/1/02 is considered non-compliant because it has failed 1.121, as amended on September 8, 2000 (see 65 Fed. Reg. 54603, Sept. 8, 2000, and 1238 O.G. 7 mendment to be compliant, applicant must supply the following omissions or corrections in response	77, Sept. 19, 2000).	ments of 37 In order for
	FOLLOWING ITEMS ARE REQUIRED FOR COMPLIANCE WITH RULE 1.121 (APPLICAL ENTIRE AMENDMENT):	NT NEED NOT RE	SUBMIT
	1. A clean version of the replacement paragraph(s)/section(s) is required. See 37 CFR 1.121(b)(1)(ii).	
)ZÍ	2. A marked-up version of the replacement paragraph(s)/section(s) is required. See 37 CFR 1.	121(b)(1)(iii).	
	3. A clean version of the amended claim(s) is required. See 37 CFR 1.121(c)(1)(i).		
	4. A marked-up version of the amended claim(s) is required. See 37 CFR 1.121(c)(1)(ii).		
Expla	nation: Abstract		•
<u>http:/</u>	PRELIMINARY AMENDMENT: Unless applicant supplies the omission or correction to to compliance with revised 37 CFR 1.121 noted above within ONE MONTH of the mail date of merits may commence without entry of the originally proposed preliminary amendment. This	the preliminary ame this letter, examina	ndment in tion on the
Ø	U.S.C. 132, and this ONE MONTH time limit is not extendable. AMENDMENT AFTER NON-FINAL ACTION: Since the above-mentioned reply appears given a TIME PERIOD of ONE MONTH or THIRTY DAYS from the mailing of this notice, which to supply the omission or correction noted above in order to avoid abandonment. EXPERIOD MAY BE GRANTED UNDER 37 CFR 1.136(a).	vhichever is longer,	within
Msi	mcenillan		
	Instruments Examiner (LIE)		
	3) 308-5848 12/01)	TECH	
(IGEV.	1401)	<u>_</u>	-77

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Washington, D.C. 20231 on the date indicated below.

Date: Hugyst 7, 2000

By: (Signature of person mailing paper of fee)

PATENT

Paper No. 4

File: Concir-2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors

Brian J. McDermott, Jr., Daniel McGowan,

Ralph Leo Spotts, and Sid Tryzbiak

Serial No.

09/694,099

Filed

20 October 2000

For

20 October 2000

IMPROVED CIRCUIT BOARD OR OTHER MULTILAYER

ELECTRICAL DEVICE MADE BY FORMING TEETH TO

JOIN LAYERS

Group Art Unit

2827

Examiner

TUAN, Dinh T.

The Commissioner of Patents and Trademarks
Washington, D.C. 20231

AMENDED VERSION OF THE ABSTRACT

SIR:

Set forth below is the amended version of the abstract.

A multilayer electrical device, such as a printed circuit board, [and method for making the electrical device] having a tooth structure [joining at least one of the layers. The method includes the following steps: providing a base; preparing the base and adding a conductive layer to the base; applying a dielectric material to the conductive layer; preparing the applied dielectric material for receipt of the conductive coating; forming openings (vias) through holes in the applied dielectric coating; etching cavities in the applied dielectric material; applying a conductive coating to the cavities in the applied dielectric material; and forming a metal layer

on the conductive coating to produce a tooth structure set in the dielectric coating. The tooth structure preferably has obtuse teeth in the range of 1-2 tenths of a mil deep that mechanically join a dielectric material to a subsequently added metal layer.] including a metal layer set in a dielectric. The device includes a base; a conductive layer adjacent to the base; a dielectric material adjacent to conductive layer; a tooth structure including a metal layer set in the dielectric material to join the dielectric material to the metal layer; and wherein the metal layer forms a portion of circuitry in a circuit board having multiple layers of circuitry.

If the prosecution of this case can be in any way advanced by a telephone discussion, the Examiner is requested to call the undersigned at (312) 240-0824.

The Commissioner is hereby authorized to charge any fees associated with the above-identified patent application or credit any overcharges to Deposit Account No. 50-0235.

Please direct all correspondence to the undersigned at the address given below.

Respectfully submitted,

(Reg. No. 32,601)

Date. 1

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